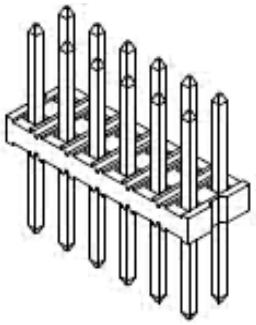
Part Number : 877580216
Product Description : 2.00mm Pitch Milli-Grid Header, Through Hole, Vertical, 2 Circuits, 0.38µm Gold (Au) Selective Plating, Pocket Tray Packaging, Lead-Free
Series Number : 87758
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

877580216_sd.pdf

PK-89990-487-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

503940001-AS-000.pdf

PS-87761-100-001.pdf

877610000-TS-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)

EU RoHS	Compliant per EU 2015/863

Compliance Statements
- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents
- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest
- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87758
Description	2.00mm Pitch Milli-Grid Header, Through Hole, Vertical, 2 Circuits, 0.38µm Gold (Au) Selective Plating, Pocket Tray Packaging, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Header
Product Name	Milli-Grid
UPC	822348270705

Agency

UL	E29179

Electrical

Current - Maximum per Contact	2.0A
Voltage - Maximum	125V

Physical

Breakaway	Yes
Circuits (Loaded)	2
Circuits (maximum)	2
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Mated Height	4.00mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Net Weight	50.292/mg
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	3
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	250

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Dual Row Receptacle Housings	51110
Milli-Grid Vertical Through Hole PCB Receptacles	78787
Milli-Grid Top Entry Surface Mount PCB Receptacles	78788
Milli-Grid Vertical Through Hole PCB Receptacles	79107
Milli-Grid Vertical Through Hole PCB Receptacles	79108
Milli-Grid Top/Bottom Entry Surface Mount PCB Receptacles	79109
Milli-Grid Top Entry Surface Mount PCB Receptacles	87381